



ELGOLINE d.o.o.

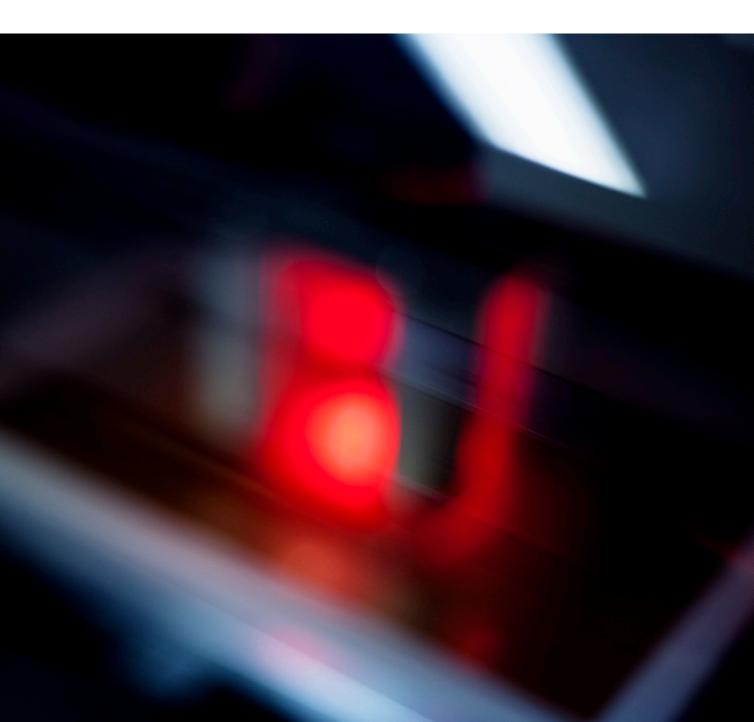
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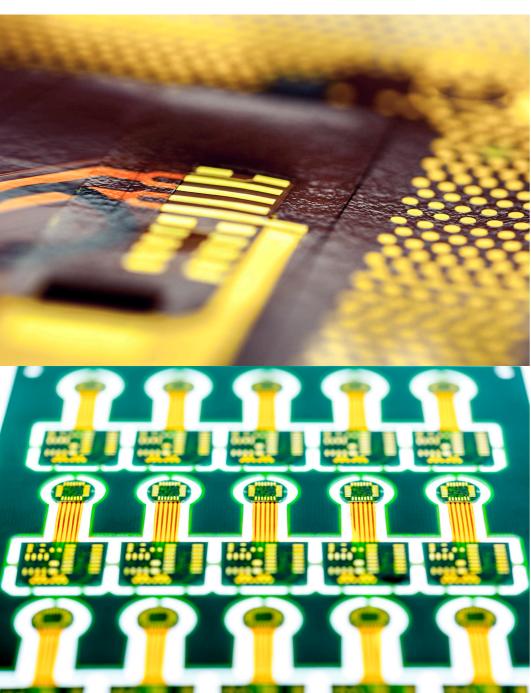
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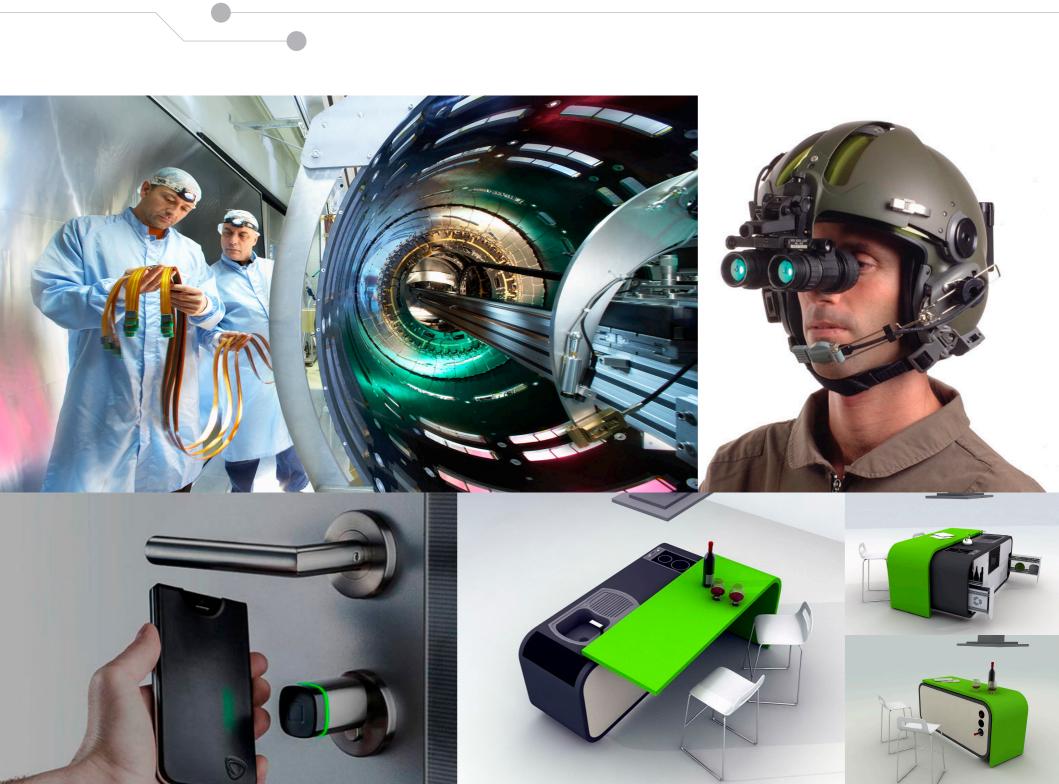
About the Company



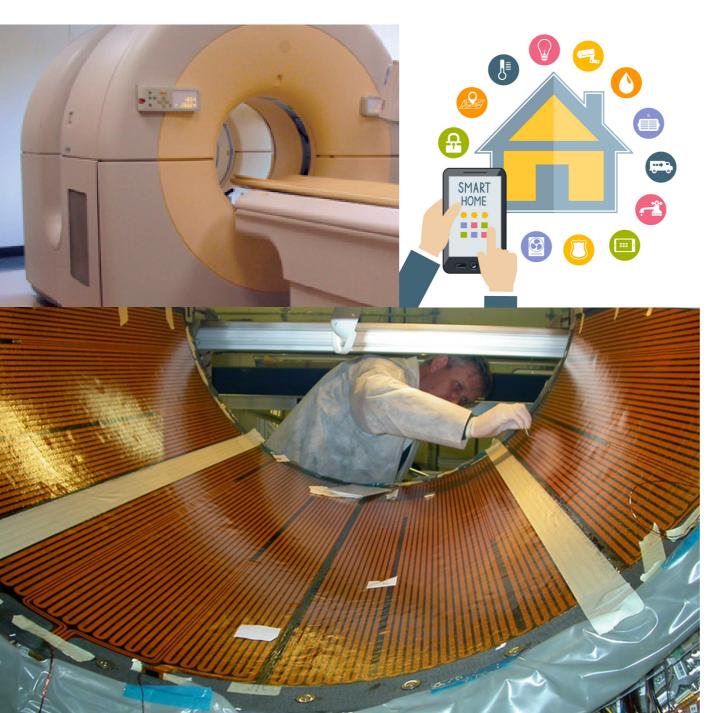
Elgoline Ltd. was founded in 1986 and has extensive experience in developing and manufacturing high quality printed circuit boards, flexible circuit boards and ribbon cables. Beside its primary manufacturing activities, the company also sells and rents its own real estate and machinery.

We are one of the leading printed circuit boards' manufacturers, providing rapid prototypes and fast deliverers within Europe. The bases of our company's development are thoughtfully defined investments, manufacturing strategies and goals. Due to the recent modernization of our production capabilities with investments in new modern equipment, we have gained a lot of knowledge in the field of manufacturing technology and development of variety of printed circuit boards.

Our research and development team is collaborating with Slovenian's leading scientific research institute, the Jožef Stefan Institute. We are very proud of our collaboration and our contribution to the project ATLAS, which is a part of Large Hadron Collider at CERN. As a result of this successful collaboration, we have received international recognition and gained a strategic position in Europe for new achievements in the electronics development.

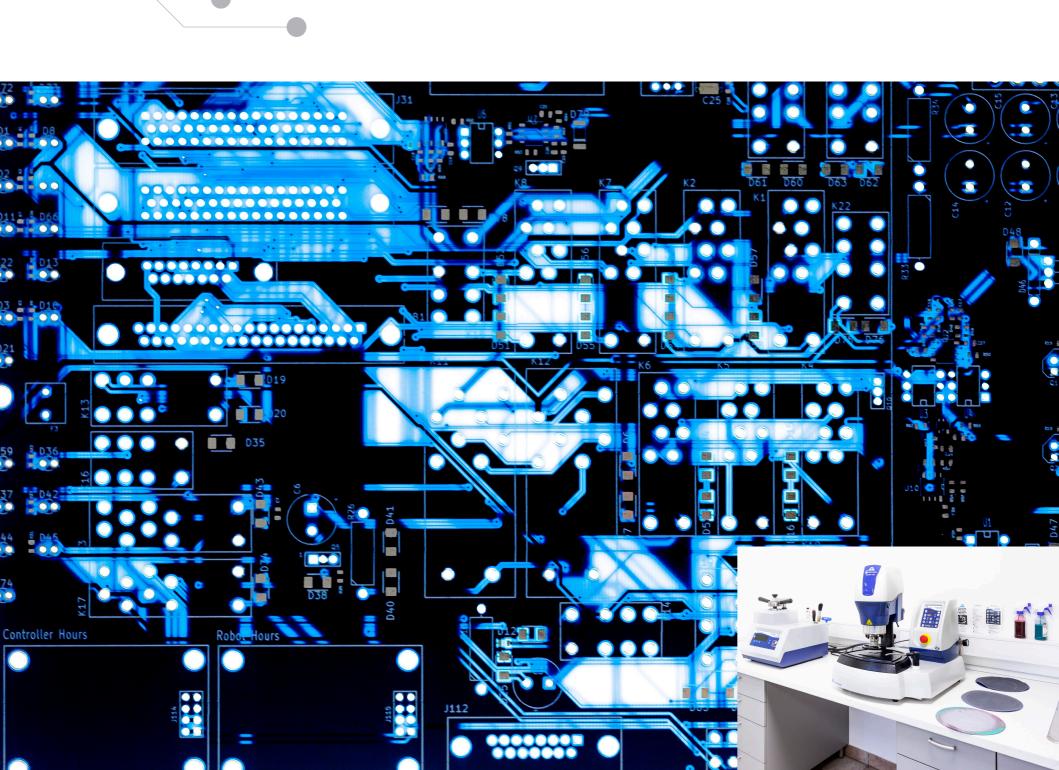


Goals and Vision

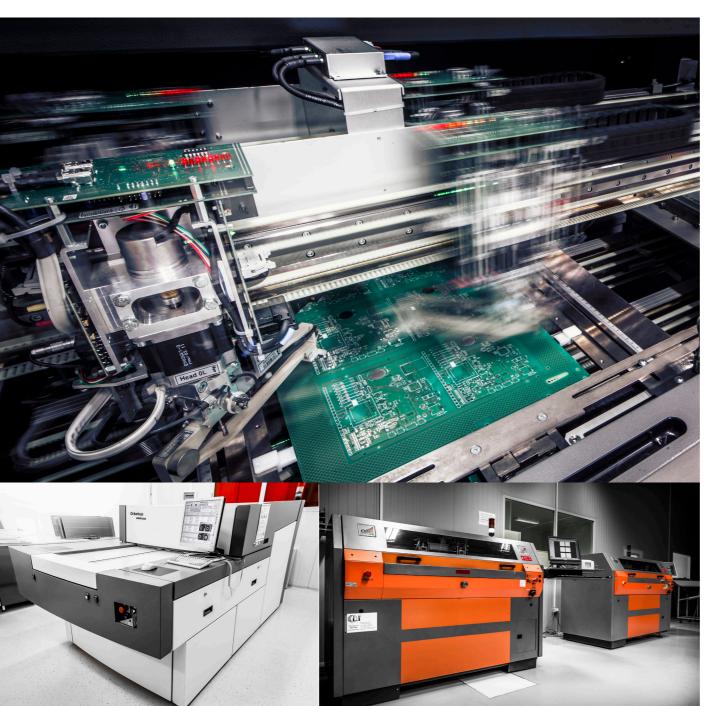


Our goal is flexibility in all respects. In addition to developing our own products, we strive for producing higher quality standards and continuously improving our products in accordance with international environmental standards, as well as offering the shortest possible delivery time and reliable customer support throughout the whole process, from the initial design all the way to the final product.

We support the development of electronics and electrical engineering. We continue to maintain our cooperation with scientific and educational institutions, such as the Jožef Stefan Institute and the Faculty of Electrical Engineering of the University of Ljubljana. With these partnerships we aim to take on new research projects and produce improved products for better future of humanity.



Quality

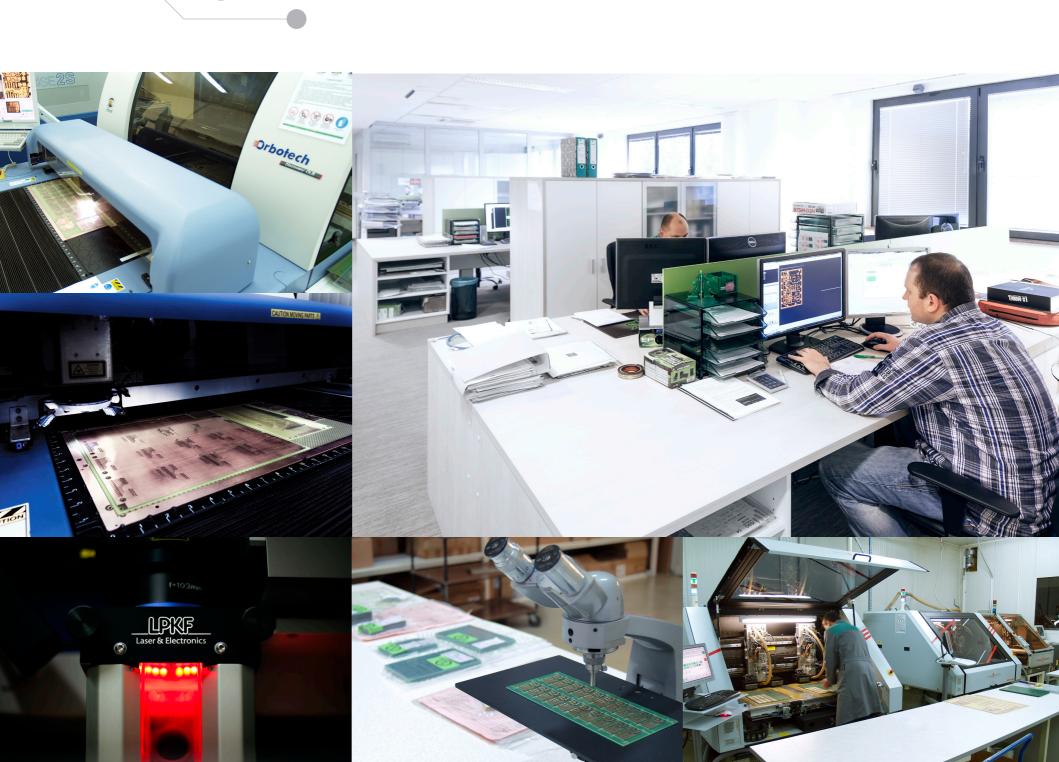




Elgoline Ltd. is one of the biggest manufacturers of printed circuit boards in Slovenia. The essential part of our strategy is producing high quality products and environmental care. We are gradually introducing the principles of the ISO 9001 quality management standard throughout our process.

Our printed circuit boards are manufactured according to the IPC-standards (IPC-A-600G). The UL Certificate assures our products are made from quality materials and are certified in international laboratories (UL Nr.: E312947). We have our own chemical laboratory, whereas specialized types of analysis are made in collaboration with certified external experts. At our customer's request, we can test physical and measurement properties of printed circuit boards and prepare various reports.

All processes within the company are documented and traceable through our quality assurance system.



Technical Capabilities of PCB



Requirement attribute Product capability

Single -, Double sided, Flex, Teflon, **Board Type:**

Multilayer, High Freq, MetalCore,...

Nr. of conductive layers: Up to 18

FR4, Halogen free, CEM1, CEM3 Laminate Materials:

> High-freq materials High Tg/CTI materials

Alu materials

PTFE, Rogers, Brass, Titanium,

Polyimide, Stainless

Max board size 610 x 457 mm for ML

> 1200 x 457 mm for SE and SD in production:

> > 5000 x 340 mm for flex

Total board thickness: 0.20 mm- 3.2 mm Inner layer thickness: 0,10 mm - 1,6 mm Min line width, space: 75 µm (25 µm)

Copper Foil Thickness on outer layers:

Copper Foil Thickness on

inner layers:

Diameter of drilled holes: Finished hole diameter: 0,10 mm - 6,35 mm

Metallization Aspect Ratio: Blind Via Aspect Ratio:

Solder resist:

 $12 \mu m - 105 \mu m$, $210 \mu m$, $400 \mu m$

 $12 \mu m - 105 \mu m$ 0,15 mm - 6,40 mm

12:1

Green matt and glossy, Black matt and glossy, White, Blue,

Red, Yellow (Min. gap in fine-

pitch 50 µm)

Requirement attribute Product capability

White, Green, Yellow, Black, Red, **Legend Print:**

Blue

Peelable Solder Mask: Peters Blue

Via filler: with solder resist Carbon print: 40 Ohm + 5% Surface Finishes: HALLead Free

HAL Tin-Lead

Immersion NiAu (ENIG)

Immersion Ag Immersion Tin

OSP Hard gold

Tolerances: Routing ± 0,10 mm

> Scoring ± 0,10 mm Etching ± 10%

Hole Tol. (Press fit) ± 0,05 mm

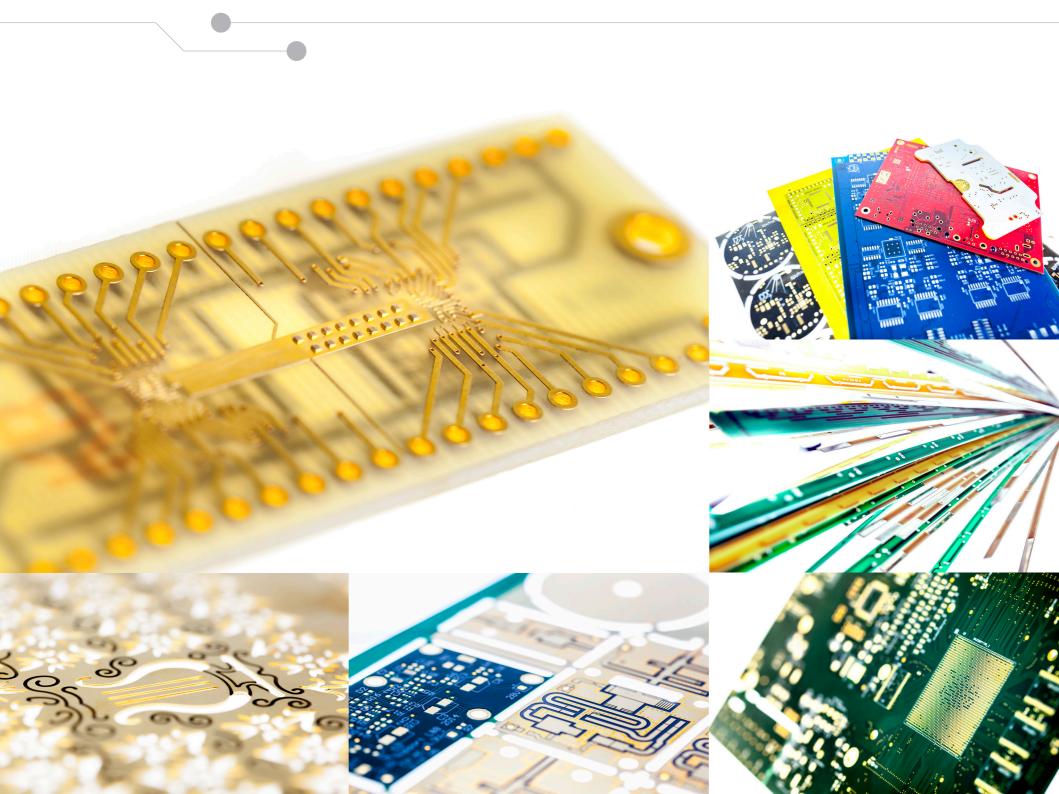
Quality Management: UL conformance

Micro section

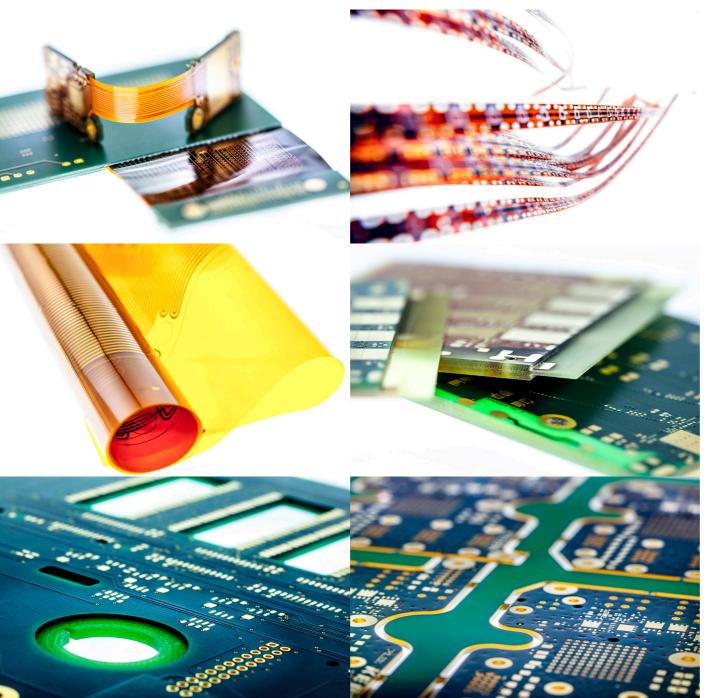
Automatic Optical Inspection

CCD

Electrical Testing



Special Features of Our Products



Thick copper PCB

Embedded PCB

BGA raster 0.5

Spacing 75 µm

Edge plating

Deep routing

High-freq materials

Brass / titanium / stainless etching

Blind Via

Burried Via

Via in pad

Plugged Via

PRESS FIT

Jump scoring

Rigid-flex PCB

Flex - boards

Ribbon cables (up to 5 m)

PCB up to 1.2 m

